REGISTRATION FEES

	Until July 10 th , 2014	After July 10 th , 2014
Congress (regular)	500 US\$	600 US\$
Congress (student)	100 US\$	150 US\$
Congress dinner	100 US\$	100 US\$
Exhibition	1000 US\$	1000 US\$

Fees include attendance at the congress, abstract, welcome party, coffee breaks and all reception except for the congress dinner.

VENUE

Nara is an old capital (AD 710-794) city of Japan and just 1.5 h from Kansai Intn'l Airport by bus transfer (every hour from 6 to 21). Nara is a very fantastic and beautiful town. Nara is surrounded with nature and old temples and shrines including Todaiji Temple (famous with the world largest Buddha bronze statue, 5 min on foot from the Congress Hall) and Kofukuji temple. The WCARP-V congress will be held in the Nara Prefectural New Public Hall

(http://www.shinkokaido.jp/english/index.html), providing main room with Japanese Noh-theater style.





ACCOMMODATION

In the 2^{nd} announcement and on the website, the organizing committee will give recommendations and offer prereservation options in hotels of different categories convenient to the congress venue. Bookings have to be made by the participants themselves.

Further information will be available at http://www.adhesion.or.jp/wcarp

1st Circular

5th World Congress on Adhesion and Related Phenomena

September 7 to 11, 2014 Nara, Japan



Organized by
The Adhesion Society of Japan

一般社団法人 日本接着学会



50th Anniversary Since 1964

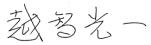
SCOPE

WCARP is an international congress held every four years. It aims at bringing together researchers and engineers from academic, technology, and industry to present and discuss the current state of progress of adhesion and related phenomena.

The 5th edition of the WCARP will be organized in the Nara Prefectural New Public Hall, Nara, Japan from September 7th to 11th, 2014.

As decided by the International Organizing Committee representing:

the Adhesion Society (USA), the Adhesion Society in Spain (Spain), Beijing Adhesion Society (China), DECHEMA e.V. (Germany), Société Française du Vide (France), the Society of Adhesion and Adhesives (United Kingdom), the Society of Adhesion and Interfaces (Korea), Associação Portuguesa de Adesão e Adesivos (Portugal), together with the Adhesion Society of Japan.



Mitsukazu Ochi Prof. Dr., Kansai University Chair of Congress

This five-day event will bring together leading experts in adhesion science and technology (chemistry, physics, mechanics, biology, medicine, agriculture, marine science etc.) and other professionals for exchanges through lectures and posters.

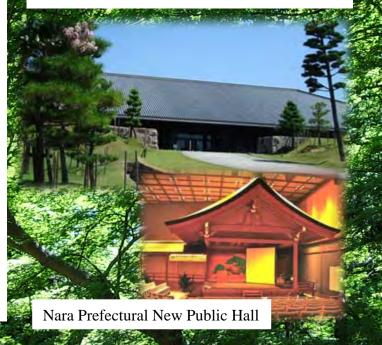
Sunday afternoon dedicated to
Plenary lectures from world wide speakers
Monday to Thursday morning
4 parallel sessions daily
Oral and poster presentations
Keynote speakers
Banquet and social program

TOPICS

- # Fundamental aspects of adhesion
- # Science and technology of surface / interface
- # Chemistry of adhesives
- # Structural joint
- # Polymer film, thin film and coatings
- # Medical aspects of adhesion
- # Bio / bioinspired adhesion
- # Particle adhesion
- # Gel & soft adhesives
- # Composites and nanocomposites
- # Eco adhesion
- # Processing of adhesion
- # High performance and high functional adhesives
- # Industrial challenges

LANGUAGE

Official language of the congress will be English.



IMPORTANT DATES

2014

Sept. 7-11 WCARP-V Congress

July 10 Deadline for reduced congress fees

May 15 Program on line April 15 Acceptance notice

Feb. 28 Deadline for one page (A4 size)

abstract submission of oral and poster presentations

Selected papers presented at the congress will be considered for publication in a special English issue of Journal of the Adhesion Society of Japan after the usual peer review process. The details of the submission will be given on the website.

ORGANIZING COMMITTEE

Chair: T. Nishino (Kobe Univ.)

Vice-chair: A. Takemura (Univ.Tokyo),

H. Kishi (Univ.Hyogo),

A. Matsumoto (Osaka City Univ.),

M. Fukuoka (Sekisui Chem.Co.,Ltd.)

Member: Y. Ando (Toa Gosei Co.Ltd.)

S. Fujii (Osaka Inst. Technol.)

T. Hayakawa (Henkel, Jpn.Ltd.)

T. Iwata (Adh.Consultant)

J. Kadota (Osaka Munic. Tech.

Res.Inst.)

K. Mieno (Jpn. Adh. Industry

Association)

Z. Miyagi (Meiji Univ.)

H. Mori (Yamagata Univ.)

T. Ogawa (Kanazawa Inst.Technol.)

C. Sato (Tokyo Inst. Technol.)

S. Takahashi (Gifu Univ.)